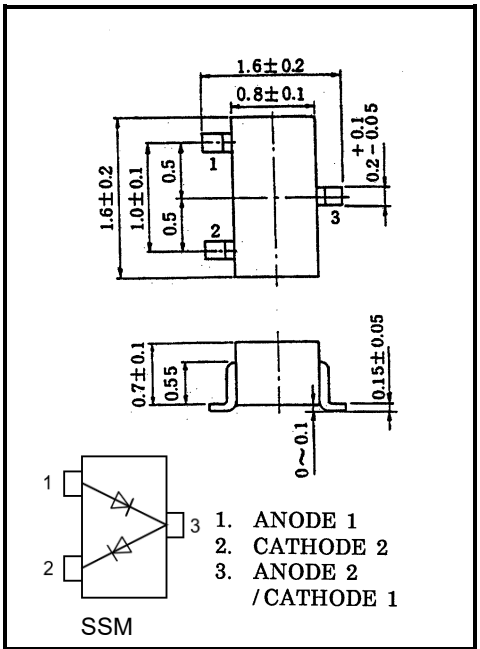
TOSHIBA Diode Silicon Epitaxial Planar Type

1SS362

Ultra High Speed Switching Application

Unit: mm

- Small package
- Low forward voltage : $V_{F(3)}$ = 0.97 V (typ.)
- Fast reverse recovery time : t_{rr} = 1.6 ns (typ.)
- Small total capacitance : C_T = 0.5 pF (typ.)



JEDEC	—
JEITA	—
TOSHIBA	1-2S1C

Weight: 2.4 mg (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V_{RM}	85	V
Reverse voltage	V_R	80	V
Maximum (peak) forward current	I_{FM}	240 *	mA
Average forward current	I_O	80 *	mA
Surge current (10ms)	I_{FSM}	1 *	A
Power dissipation	P_D (Note 1, 3)	120	mW
	P_D (Note 2)	100	
Junction temperature	T_j (Note 1)	150	°C
	T_j (Note 2)	125	
Storage temperature	T_{stg} (Note 1)	−55 to 150	°C
	T_{stg} (Note 2)	−55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For devices with the ordering part number ending in (TE85L,F).
Note 2: For devices with the ordering part number in other than (TE85L,F).
Note 3: Mounted on a FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.36 mm^2 × 3)

*: Unit rating. Total rating = Unit rating × 1.5.

Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward voltage	$V_{F\ (1)}$	I_F = 1 mA	—	0.63	—	V
	$V_{F\ (2)}$	I_F = 10 mA	—	0.75	—	
	$V_{F\ (3)}$	I_F = 100 mA	—	0.97	1.20	
Reverse current	$I_{R\ (1)}$	V_R = 30 V	—	—	0.1	μA
	$I_{R\ (2)}$	V_R = 80 V	—	—	0.5	
Total capacitance	C_T	V_R = 0 V, f = 1 MHz	—	0.5	3.0	pF
Reverse recovery time	t_{rr}	I_F = 10 mA, Fig.1	—	1.6	4.0	ns

Start of commercial production
1990-10

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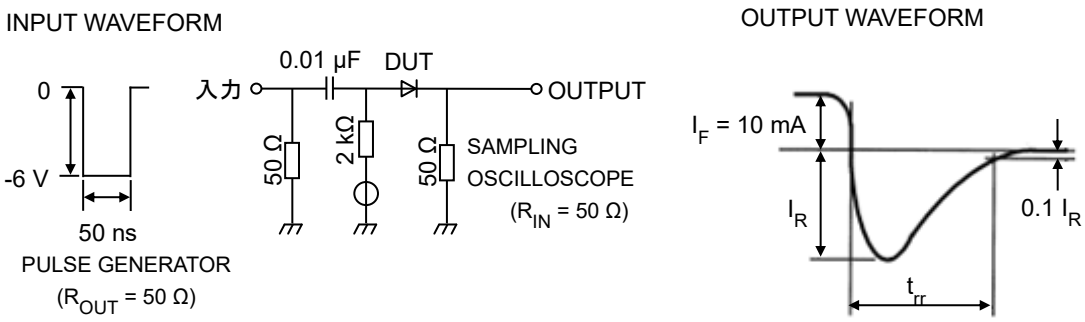
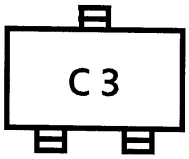
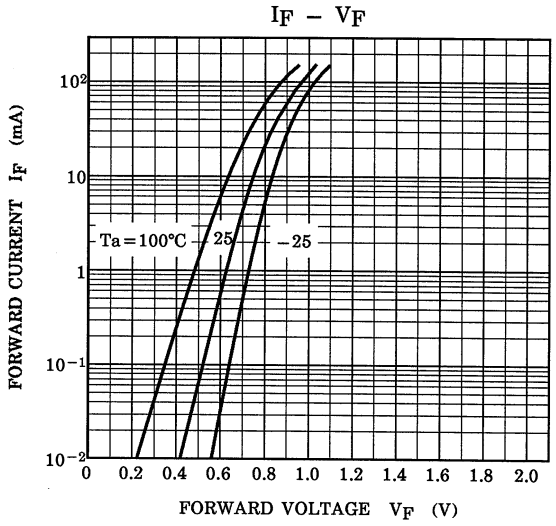


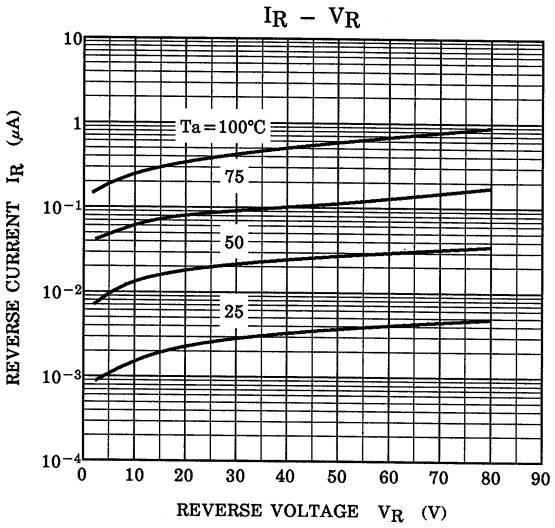
Fig.1 Reverse Recovery Time (t_{rr}) Test Circuit

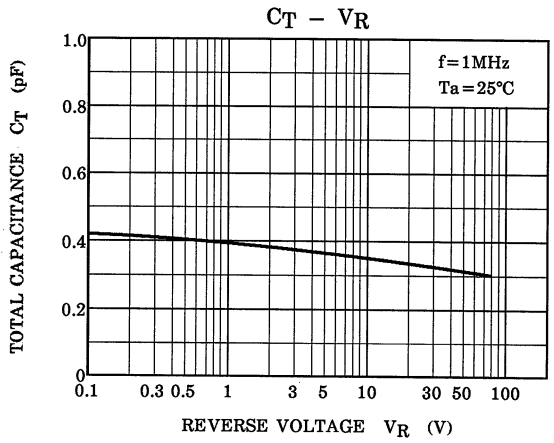
Marking

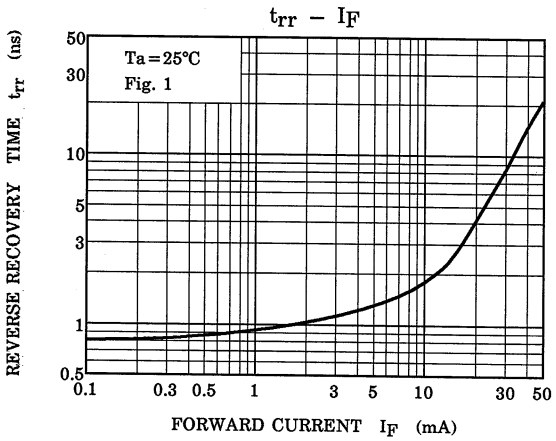


Characteristics Curves









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